**ORDER DESCRIPTION**

1. **Object of the contract**

The subject of the order is the supply of silicon polishes listed below by name and quantity needed:

* Si-wafers 4” 60 pcs
* Si-wafers 2” 20 pcs
* Si-wafers 4” 20 pcs
1. **The scope of the subject of the contract**

A detailed description of the subject of the contract is provided in section 5 of this document.

1. **Criterion**

Offers will be evaluated according to a point scale with a maximum number of points of 100.

|  |  |  |
| --- | --- | --- |
| Criterion | Maximum number of points S | Method of awarding points |
| Price net (P) | 100 | S x Pmin/Pi |

Where:

* Pi – net price of goods with delivery - for the given offer
* Pmin - the minimum delivery net price for the ordered goods from all offers submitted
* S – number of points

The final score will be calculated by adding up the partial components and then rounded to two decimal places (rounded from "5" up).

1. **Deadline for completing the order:**

**As soon as possible, no later than 9 weeks from the date of placing the order**

1. **Parameters**

**5.1 Detailed scope of the subject**

|  |  |  |  |
| --- | --- | --- | --- |
| Product name |  | Parametrer | Specification |
| **Si-Wafer 4”** | Diameter 4” Diameter: 100 ±0.3 mmThickness: 400 ±20 μm | Grade: | Epi-ready grade |
| Growth method | FZ |
| Dopant | undoped |
| Orientation: | <100> ±0.5° |
| Resistivity: | >10,000 Ohm-cm |
| TTV | <10 μm |
| Surface Finish: | Double Side Polished |
| Packaging: | Cassette |
| **Si-Wafer 2”** | Diameter 2” Diameter: 50.8 ±0.3 mGrubość:279 ±15 μm | Grade: | Prime |
| Growth method | CZ |
| Dopant | undoped |
| Orientation: | <100> ±1° |
| Conduct type | P/B |
| Resistivity: | 1-5 Ohm-cm |
| TTV | <10 μm |
| Surface Finish: | Double Side Polished |
| Packaging: | Standard cassettes, sealed in bags |
| **Si-Wafer 4”** | Diameter 4” Diameter: 100 ±0.2 mmThickness:525 ±15 μm | Grade: | Prime |
| Growth method | CZ |
| Dopant | undoped |
| Orientation: | <100> ±0.5° |
| Conduct type | P/B |
| Resistivity: | 0.01-0.02 Ohm-cm |
| TTV | <5 μm |
| Surface Finish: | Double Side Polished |
| Packaging: | Standard cassettes, sealed in bags |